Work-In-Progress

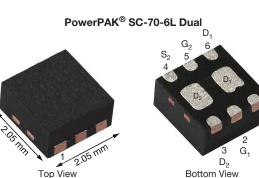


SiA906EDJ

Vishay Siliconix

Dual N-Channel 20 V (D-S) MOSFET

S



Marking code: CC

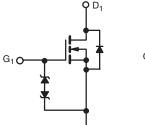
PRODUCT SUMMARY				
V _{DS} (V)	20			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.046			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 2.5 V	0.063			
Q _g typ. (nC)	3.5			
I _D (A) ^a	4.5			
Configuration	Dual			

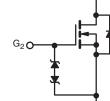
FEATURES

- TrenchFET[®] power MOSFET
- New thermally enhanced PowerPAK[®] SC-70 package
 Small footprint area
 Low on-resistance
- Typical ESD protection 560 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Load switch for portable applications
- High frequency DC/DC converter





N-Channel MOSFET OS

N-Channel MOSFET OS2

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA906EDJ-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	20	V	
Gate-source voltage		V _{GS}	± 12	v	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		4.5 ^a		
	T _C = 70 °C	I _D	4.5 ^a		
	T _A = 25 °C		4.5 ^{a, b, c}		
	T _A = 70 °C	1	4.1 ^{b, c}	A	
Pulsed drain current		I _{DM}	15		
Continuous source-drain diode current	T _C = 25 °C		4.5 ^a		
	T _A = 25 °C	I _S	1.6 ^{b, c}		
Maximum power dissipation	T _C = 25 °C	– P _D	7.8		
	T _C = 70 °C		5	w	
	T _A = 25 °C		1.9 ^{b, c}	vv	
	T _A = 70 °C	1	1.2 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260	U	

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	SYMBOL TYPICAL MAXIMUM		UNIT	
Maximum junction-to-ambient b, f	t ≤ 5 s	R _{thJA}	52	65	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	12.5	16		

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 110 °C/W

SPending-Rev. B, 01-Oct-10

1

Pb-free

RoHS COMPLIANT HALOGEN FREE

 D_2

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	23	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-3.3	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6	-	1.4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	-	-	± 8		
Zero gate voltage drain current		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μA	
	IDSS	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 5$ V, $V_{GS} = 4.5$ V	10	-	-	Α	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$	-	0.037	0.046	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 3.3 \text{ A}$	-	0.051	0.063		
Forward transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$	-	14	-	S	
Dynamic ^b	· ·						
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	-	350	-	pF	
Output capacitance	C _{oss}		-	63	-		
Reverse transfer capacitance	C _{rss}		-	- 37 -	1		
-	_	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5.1 \text{ A}$	-	7.5	12	nC	
Total gate charge	Qg		-	3.5	5.5		
Gate-source charge	Q _{gs}	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.1 \text{ A}$	-	0.95	-		
Gate-drain charge	Q _{gd}		-	0.75	-		
Gate resistance	R _q	f = 1 MHz	0.7	3.5	7	Ω	
Turn-on delay time	t _{d(on)}		-	10	15	ns	
Rise time	tr	$V_{DD} = 10 \text{ V}, \text{ R}_{\text{L}} = 2.4 \Omega$	-	12	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 4.1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	18	30		
Fall time	t _f		-	12	20		
Turn-on delay time	t _{d(on)}		-	5	10		
Rise time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{\text{L}} = 2.4 \Omega$	-	12	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 4.1 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	15	25		
Fall time	t _f		-	10	15		
Drain-Source Body Diode Characterist	ics					1	
Continuous source-drain diode current	ا _S	T _C = 25 °C	-	-	4.5		
Pulse diode forward current	I _{SM}		-	-	15	A	
Body diode voltage	V _{SD}	I _S = 4.1 A, V _{GS} = 0 V	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}	l _F = 4.1 A, di/dt = 100 A/μs,	-	15	30	ns	
Body diode reverse recovery charge	Q _{rr}		_	8	20	nC	
Reverse recovery fall time	ta	$T_J = 25 \ ^\circ C$	-	8	-	ns	
Reverse recovery rise time	t _b		-	7	<u> </u>		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

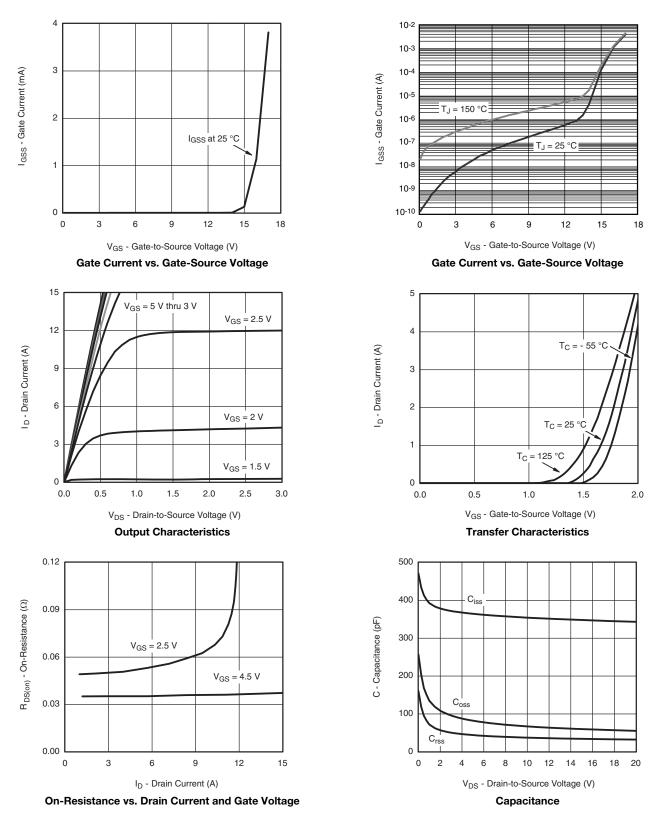
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



SPending-Rev. B, 01-Oct-10

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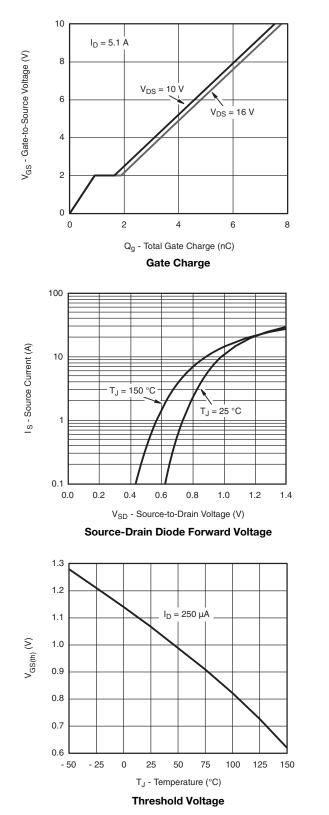
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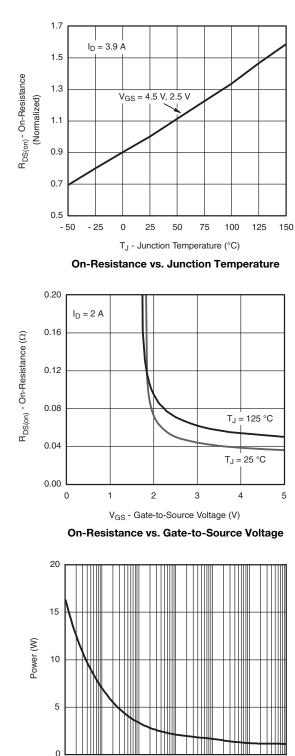
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Pulse (s)
Single Pulse Power (Junction-to-Ambient)

1

10

100

SPending-Rev. B, 01-Oct-10

4

0.001

0.01

0.1

Document Number: 69067

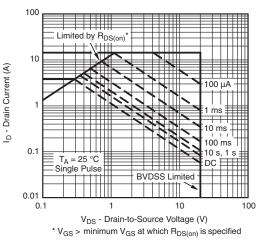
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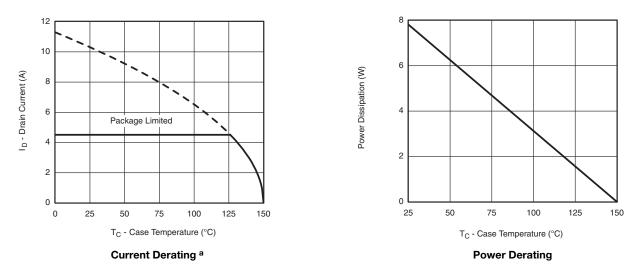


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient



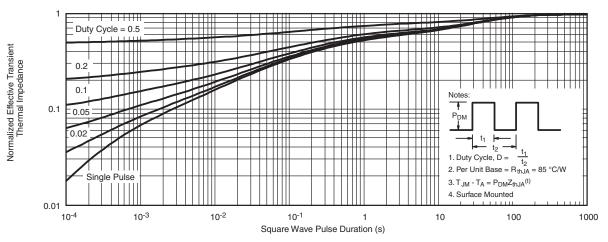
Note

a. The power dissipation P_D is based on T_J max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69067.

6



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

¥

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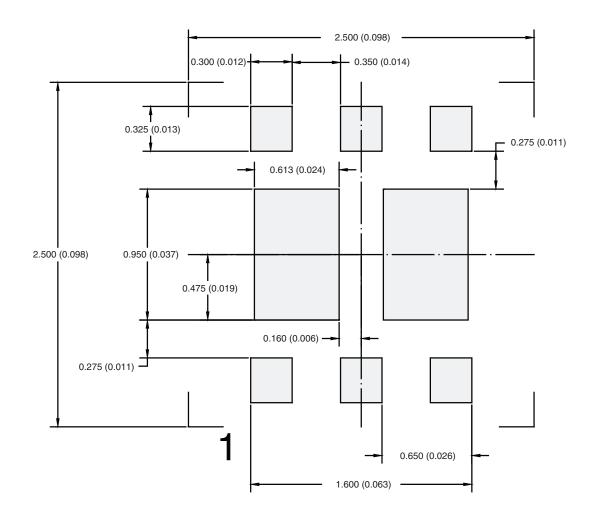
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Application Note 826

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RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

Return to Index



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